3RA-6 Series

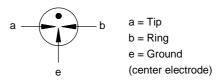
Description

GDT is placed in front of, and in parallel with, sensitive telecom equipment such as power lines, communication lines, signal lines and data transmission lines to help protect them from damage caused by transient surge voltages that may result from lightning strikes and equipment switching operations. These devices do not influence the signal in normal operation. However, in the event of an overvoltage surge, such as a lightning strike, the GDT switches to a low impedance state and diverts the energy away from the sensitive equipment.

Our GDT offer a high level of surge protection, a broad voltage range, low capacitance, and many form factors including new surface mount devices, which makes them suitable for applications such as Main Distribution Frame (MDF) modules, high data-rate telecom applications (e.g. ADSL, VDSL), and surge protection on power lines. Their low capacitance also results in less signal distortion. When used in a coordinated circuit protection solution with PolySwitch devices, they can help equipment manufacturers meet stringent safety regulatory standards.



Electrical symbol



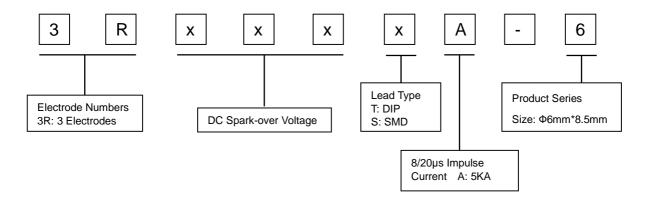
Features

- I Excellent response to fast rising transients
- I Stable breakdown voltage
- I GHz working frequency
- I 8/20µs Impulse current capability: 10KA
- I Non-Radioactive
- I Ultra Low capacitance (<1.5pF)
- I High insulation resistance
- I Lead-free and RoHS compliant
- I UL 497B Recognized: E465335
- I Size: Φ6mm*8.5mm
- I Storage and operational temperature: -40~+90°C

Applications

- Communication equipment
- I CATV equipment
- I Data lines
- I Power supplies
- I Telecom SLIC protection
- I Broadband equipment
- ADSL equipment, including ADSL2+
- I XDSL equipment
- I Satellite and CATV equipment
- I Test equipment
- I Consumer electronics

Part Number Code



Revised: 2017-04-25





3RA-6 Series

Electrical Characteristics

Part Number			Impul				II :anacitance	Life Ratings			
			DC Spark-over Voltage ^{1) 2)} @100V/S	Spark-over Voltage ³⁾ 100V/µS 1KV/µS		Insulation Resistance		Impulse Discharge Current @8/20µs ⁵⁾		AC Discharge Current @50Hz 1S 5)	Impulse Life @10/1000µS 100A 5)
				Max	Max	Min	Max	Nominal ±5 times	Max 1 time	Nominal 5 times	Min
DIP	SMD	DIP-F	v	٧	v	GΩ	pF	KA	KA	Α	Times
3R070TA-6	3R070SA-6	3R070TA-6F	70±20%	500	600	1	1.5	5	10	5	300
3R075TA-6	3R075SA-6	3R075TA-6F	75±20%	500	600	1	1.5	5	10	5	300
3R090TA-6	3R090SA-6	3R090TA-6F	90±20%	500	600	1	1.5	5	10	5	300
3R150TA-6	3R150SA-6	3R150TA-6F	150±20%	500	600	1	1.5	5	10	5	300
3R230TA-6	3R230SA-6	3R230TA-6F	230±20%	500	700	1	1.5	5	10	5	300
3R250TA-6	3R250SA-6	3R250TA-6F	250±20%	500	700	1	1.5	5	10	5	300
3R300TA-6	3R300SA-6	3R300TA-6F	300±20%	700	900	1	1.5	5	10	5	300
3R350TA-6	3R350SA-6	3R350TA-6F	350±20%	700	900	1	1.5	5	10	5	300
3R400TA-6	3R400SA-6	3R400TA-6F	400±20%	800	1000	1	1.5	5	10	5	300
3R470TA-6	3R470SA-6	3R470TA-6F	470±20%	900	1100	1	1.5	5	10	5	300
3R600TA-6	3R600SA-6	3R600TA-6F	600±20%	1100	1300	1	1.5	5	10	5	300
3R800TA-6	3R800SA-6	3R800TA-6F	800±20%	1300	1500	1	1.5	5	10	5	300
Glow Voltage at 10mA~60V											
Arc Voltage at 1A~10V											
Glow to Arc transition Current~1A											
Operation and storage -40~90°C											
Climatic category (IEC60068-1)											
Marking, Black							Current				
Weight~1.25g											
Surface treatment					DIP SMD	-Nickel Pla -Matte-tin					

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70V, 75V at DC 25V 90V~150V at DC 50V Other at DC 100V

Terms in accordance with ITU-T Rec. K.12, IEC 61643-311, GB/T 9043.



¹⁾ At delivery AQL 0.65 level II, DIN ISO 2859

²⁾ In ionized mode

³⁾ Tip or ring electrode to center electrode

⁴⁾ Insulation Resistance Measuring Voltage:

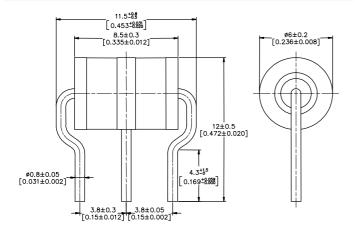
⁵⁾ Total current through center electrode, half value through tip respectively ring electrode.



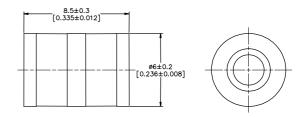
3RA-6 Series

Dimensions (Unit: mm/inch)

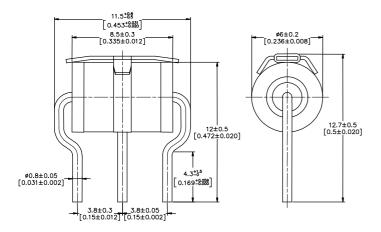
DIP Series (3RxxxTA-6)



SMD Series (3RxxxSA-6)

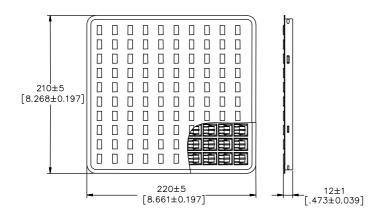


DIP Series (3RxxxTA-6F)



Packaging Information (Unit: mm/inch)

"DIP Series" and "DIP-F Series" Packaging (Bulk)



100PCS/ Plastic Tray

62 [2.441]

230

[9.055]

215

[8.465]

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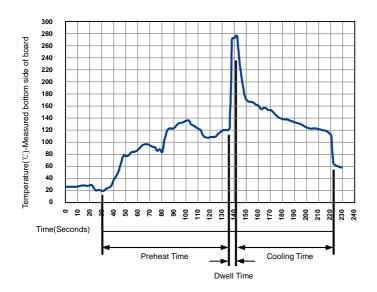
500PCS, 5 Plastic Trays / Inner Box

361° Circuit Protection System

Revised: 2017-04-25

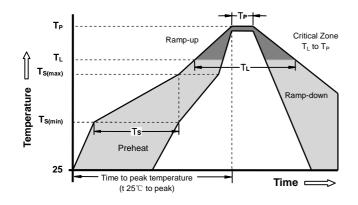
3RA-6 Series

Soldering Parameters - Wave soldering (Thru-Hole Devices)



Wave Sol	dering Condition	Pb-Free assembly			
	Temperature Min	100°C			
Preheat	Temperature Max	150°C			
	Time (Min to Max)	60-180 Seconds			
Solder Po	t Temperature	280°C Max			
Solder Dv	vell Time	2-5 Seconds			

Soldering Parameters - Reflow Soldering (Surface Mount Devices)



Reflow Co	ondition	Pb - Free assembly			
	-Temperature Min (T _{s(min)})	150°C			
Preheat	-Temperature Max (T _{s(max)})	200°C			
	- Time (min to max) (t _s)	60 -180 Seconds			
Average r T _L) to pea	amp up rate (Liquids Temp k	3°C/second max			
T _{S(max)} to T	L - Ramp-up Rate	5°C/second max			
Reflow	- Temperature (T _L) (Liquids)	217°C			
	- Time (min to max) (t _s)	60 -150 Seconds			
Peak Tem	perature (T _P)	260 +0/-5°C			
Time with Temperat	in 5°C of actual peak ure (t _p)	10 - 30 Seconds			
Ramp-dov	wn Rate	6°C/second max			
Time 25°C	to peak Temperature (T _P)	8 minutes Max			
Do not ex	ceed	260°C			

